

Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time
- Low Reverse Capacitance
- Ultra-Small Surface Mount Package
- **Lead Free By Design/RoHS Compliant (Note 1)**
- "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)



Top View

Maximum Ratings

@ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	40	V
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(\text{RMS})}$	28	V
Forward Continuous Current (Note 2)	I_{FM}	250	mA
Non-Repetitive Peak Forward Surge Current @ $t \leq 1.0\text{s}$	I_{FSM}	1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P_D	150	mW
Thermal Resistance, Junction to Ambient Air (Note 2)	$R_{\theta JA}$	667	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125	°C

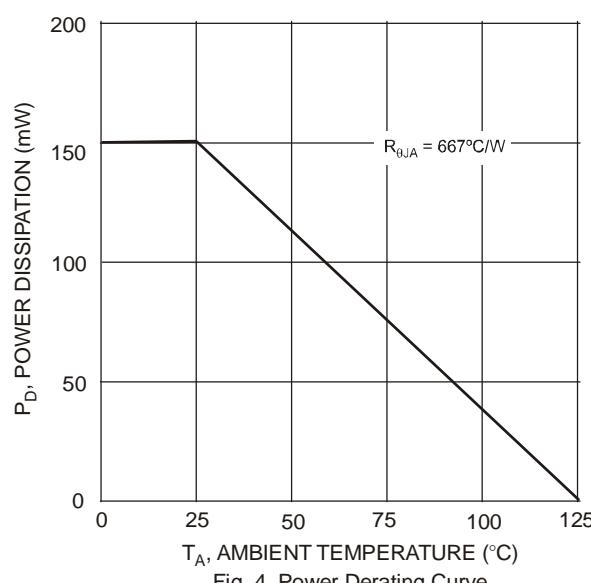
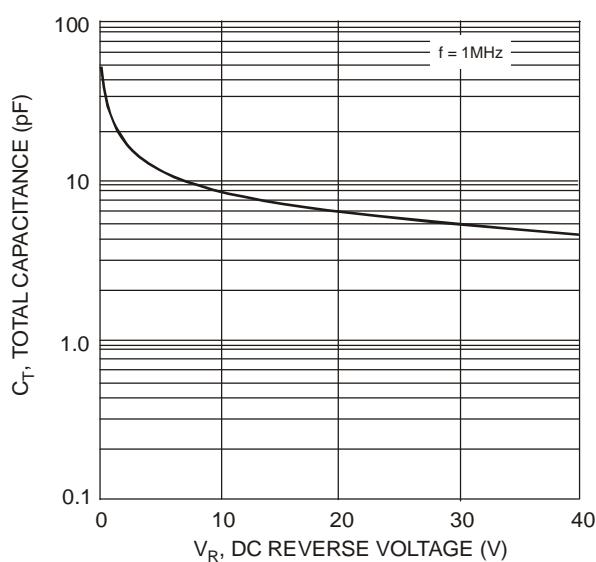
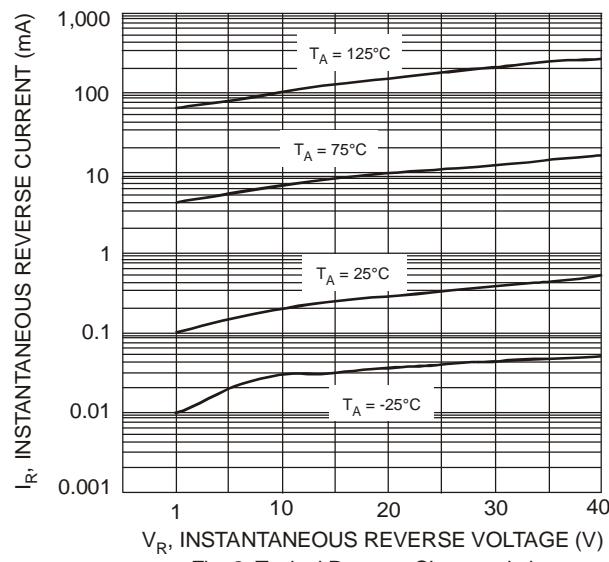
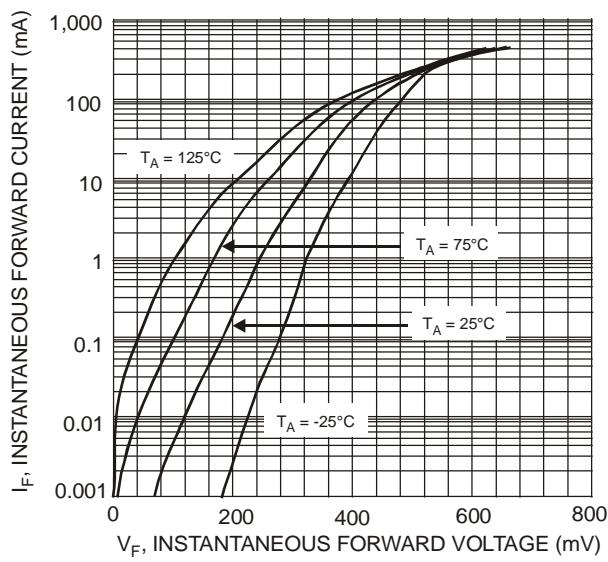
Electrical Characteristics

@ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	40	—	—	V	$I_R = 10\mu\text{A}$
Forward Voltage Drop	V_F	—	—	0.37 0.60	V	$I_F = 20\text{mA}$ $I_F = 200\text{mA}$
Peak Reverse Current (Note 5)	I_R	—	—	5 1	μA	$V_R = 30\text{V}$ $V_R = 10\text{V}$
Total Capacitance	C_T	—	50	—	pF	$V_R = 0\text{V}, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	—	10	—	ns	$I_F = I_R = 200\text{mA}$, $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

Notes:

1. No purposefully added lead.
2. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
3. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
4. Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
5. Short duration pulse test used so as to minimize self-heating effect.



Ordering Information (Notes 4 and 6)

Device	Packaging	Shipping
SDM20U40-7 (Note 7)	SOD-523	3000/Tape & Reel

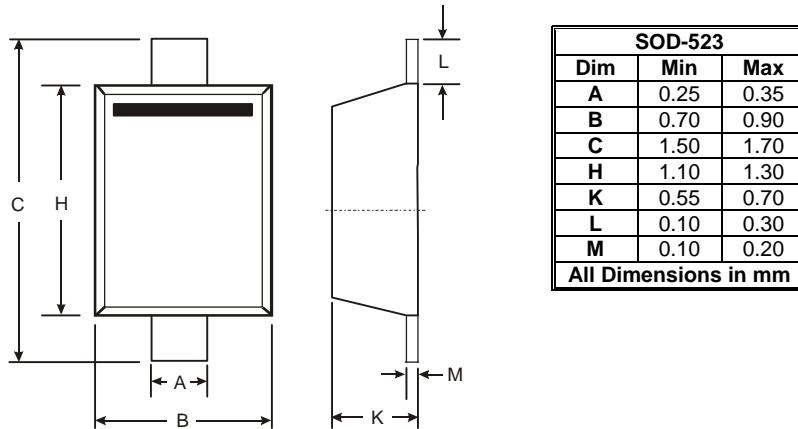
Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.
7. Dispensed in every other cavity of the tape.

Marking Information

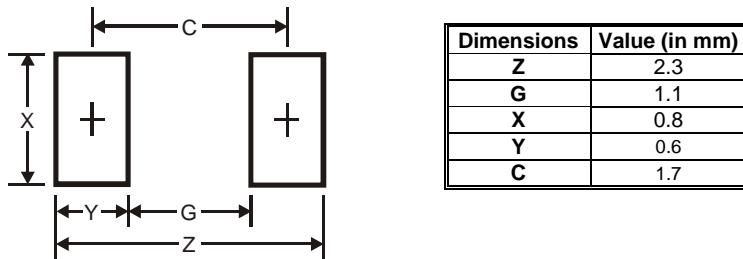


S4 = Product Type Marking Code

Package Outline Dimensions



Suggested Pad Layout



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